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## FDMA1027P

### **Dual P-Channel PowerTrench<sup>®</sup> MOSFET**

#### **General Description**

This device is designed specifically as a single package solution for the battery charge switch in cellular handset and other ultra-portable applications. It features two independent P-Channel MOSFETs with low on-state resistance for minimum conduction losses. When connected in the typical common source configuration, bi-directional current flow is possible.

The MicroFET 2x2 package offers exceptional thermal performance for it's physical size and is well suited to linear mode applications.

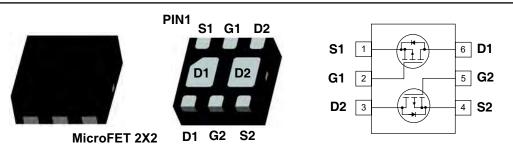


#### July 2014

FDMA1027P Dual P-Channel PowerTrench<sup>®</sup> MOSFET

#### Features

- -3.0 A, -20V.  $R_{DS(ON)} = 120 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$  $R_{DS(ON)} = 160 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$  $R_{DS(ON)} = 240 \text{ m}\Omega @ V_{GS} = -1.8 \text{ V}$
- Low Profile 0.8 mm maximun in the new package MicroFET 2x2 mm
- RoHS Compliant
- Free from halogenated compounds and antimony oxides



#### Absolute Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	MOSFET Drain-Source Voltage		-20	V
V <sub>GSS</sub>	MOSFET Gate-Source Voltage		±8	V
I <sub>D</sub>	Drain Current -Continuous	(Note 1a)	-3.0	A
	-Pulsed		-6	
P <sub>D</sub>	Power dissipation	(Note 1a)	1.4	
		(Note 1b)	0.7	
		(Note 1c)	1.8	— w
		(Note 1d)	0.8	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance for Single Operation, Junction-to-Ambient	(Note 1a)	86	
$R_{\theta JA}$	Thermal Resistance for Single Operation, Junction-to-Ambient	(Note 1b)	173	°C/W
$R_{\theta JA}$	Thermal Resistance for Dual Operation, Junction-to-Ambient	(Note 1c)	69	10/10
$R_{\theta JA}$	Thermal Resistance for Dual Operation, Junction-to-Ambient	(Note 1d)	151	

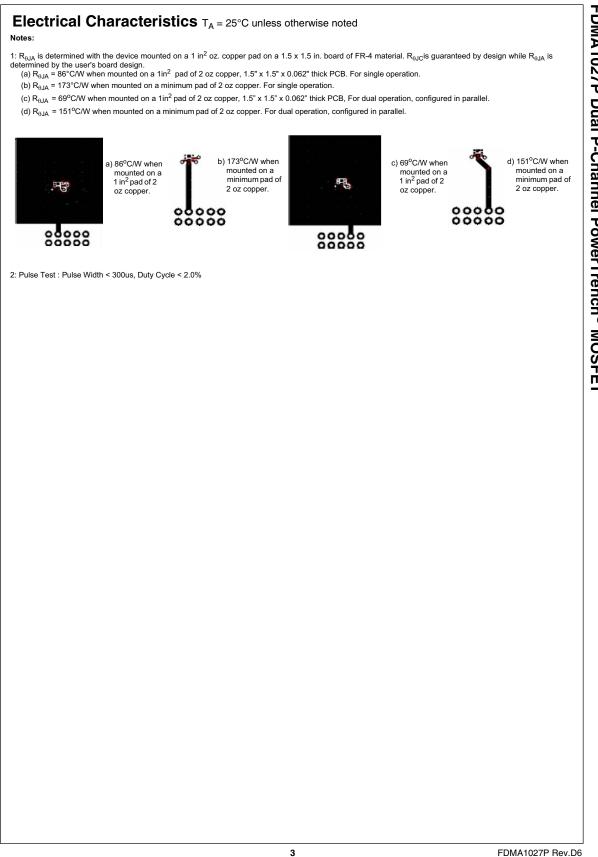
#### Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
027	FDMA1027P	7"	8mm	3000 units

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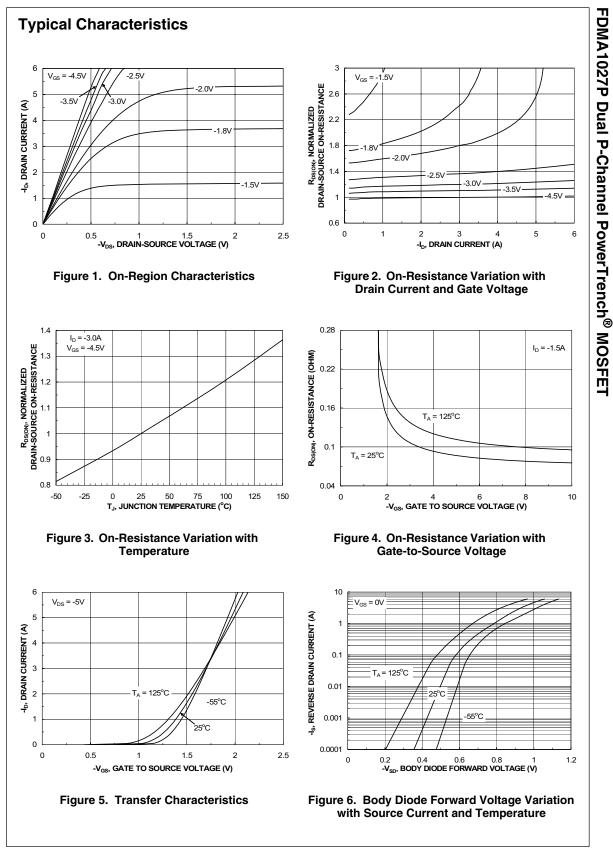
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-20	_	-	V
∆BV <sub>DSS</sub>	Breakdown Voltage Temperature	$I_{\rm D} = -250 \mu {\rm A},$				-
$\Delta T_J$	Coefficient	Referenced to 25°C	-	-12	-	mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = -16V, V_{GS} = 0V$	-	-	-1	μA
I <sub>GSS</sub>	Gate-Body Leakage,	$V_{GS} = \pm 8V, V_{DS} = 0V$	-	-	±100	nA
On Chara	cteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.4	-0.7	-1.3	V
$\Delta V_{GS(th)}$	Gate Threshold Voltage	$I_{\rm D} = -250 \mu A,$		0		
$\Delta T_J$	Temperature Coefficient	Referenced to 25°C	-	2	-	mV/°C
		$V_{GS} = -4.5V, I_D = -3.0A$	-	90	120	
		$V_{GS} = -2.5V, I_D = -2.5A$	-	120	160	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -1.8V, I_D = -1.0A$	-	172	240	mΩ
		$V_{GS} = -4.5V, I_D = -3.0A$ $T_J = 125^{\circ}C$	-	118	160	
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = -4.5V, V_{DS} = -5V$	-20	-	-	A
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5V, I_D = -3.0A$	-	7	-	S
Dvnamic	Characteristics	•				
C <sub>iss</sub>	Input Capacitance		-	435	-	pF
C <sub>oss</sub>	Output Capacitance	$-V_{DS} = -10V, V_{GS} = 0V,$	-	80	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1.0MHz	-	45	-	pF
			-	9	18	ns ns
	Turn-On Delay Time Turn-On Rise Time	$-1_{V_{DD}}10_{V_{DD}}14_{V_{DD}}$	-	11	19	
t <sub>d(on)</sub> t <sub>r</sub> td(off)	Turn-On Rise Time	$V_{DD} = -10V, I_D = -1A$ $V_{GS} = -4.5V, R_{GEN} = 6\Omega$	-	11 15	19 27	
t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Rise Time Turn-Off Delay Time	$V_{DD} = -10V, I_D = -1A$ $V_{GS} = -4.5V, R_{GEN} = 6\Omega$		11 15 6	19 27 12	ns
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$	-	15	27	
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DS} = -10V, I_D = -3.0A,$	-	15 6	27 12	ns ns
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub>	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$	-	15 6 4	27 12 6	ns ns nC
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge         Gate-Source Charge         Gate-Drain Charge	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DS} = -10V, I_D = -3.0A, V_{GS} = -4.5V$	-	15 6 4 0.8	27 12 6	ns ns nC nC
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gd</sub> Drain-Sou	Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge         Gate-Source Charge	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DS} = -10V, I_D = -3.0A,$ $V_{GS} = -4.5V$ Maximum Ratings	-	15 6 4 0.8	27 12 6	ns ns nC nC
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gd</sub> Drain-Sou I <sub>S</sub>	Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge         Gate-Source Charge         Gate-Drain Charge         urce Diode Characteristics and	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DS} = -10V, I_D = -3.0A,$ $V_{GS} = -4.5V$ Maximum Ratings de Forward Current	-	15 6 4 0.8	27 12 6 -	ns ns nC nC nC
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gd</sub> Drain-Sou	Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge         Gate-Source Charge         Gate-Drain Charge         urce Diode Characteristics and         Maximum Continuous Drain-Source Dio	$V_{GS} = -4.5V, R_{GEN} = 6\Omega$ $V_{DS} = -10V, I_D = -3.0A,$ $V_{GS} = -4.5V$ Maximum Ratings	- - - - - -	15 6 4 0.8 0.9	27 12 6 - -	ns ns nC nC nC

FDMA1027P Rev.D6



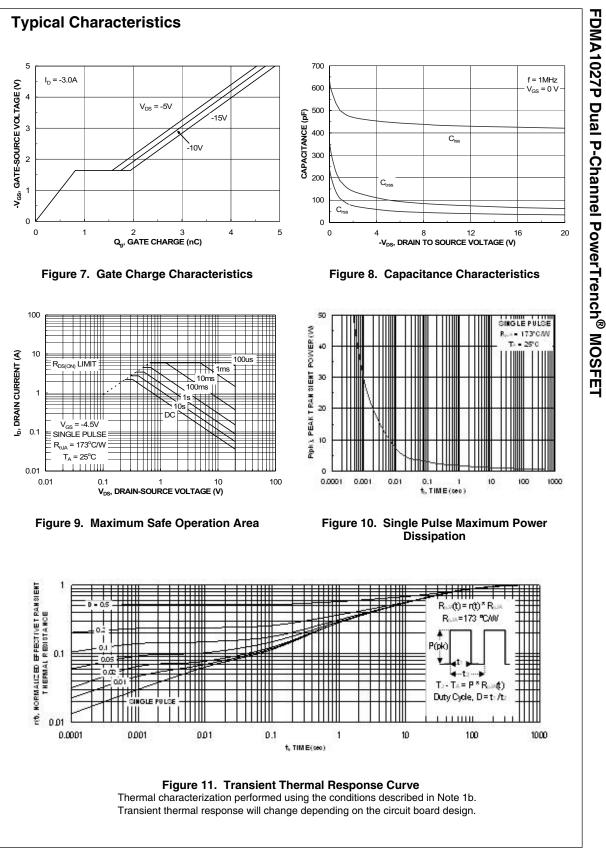
FDMA1027P Dual P-Channel PowerTrench<sup>®</sup> MOSFET

FDMA1027P Rev.D6

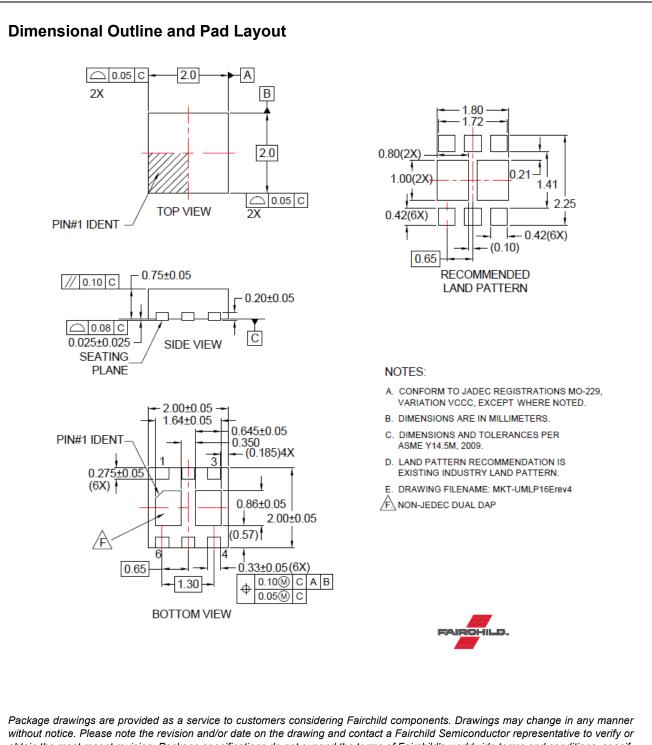


FDMA1027P Rev. D6

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FDMA1027P Rev. D6



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Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
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